

## PATENT ASSIGNMENT COVER SHEET

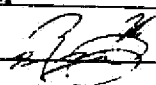
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Stylesheet Version v1.2

EPAS ID: PAT3495477

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JAE-HEAN KIM	07/23/2014
CHANG-WOO CHU	07/23/2014
YOUNG-MI CHA	07/23/2014
JIN-SUNG CHOI	07/23/2014
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14444030
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<b>DATE SIGNED:</b>	08/24/2015
<b>Total Attachments: 2</b>	
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**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN  
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE**

Title of Invention	IMAGE PROCESSING METHOD AND APPARATUS FOR CALIBRATING DEPTH OF DEPTH SENSOR
<p>As the below named inventor, I hereby declare that:  This declaration <input type="checkbox"/> The attached application, or  is directed to: <input type="checkbox"/> United States application or PCT international application number _____  filed on _____</p> <p>The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  WHEREAS, ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE  (hereinafter referred to as "ASSIGNEE"), whose post-office address is 218, Gajeong-ro, Yuseong-gu, Daejeon, 305-700,  Republic of Korea, is desirous of acquiring the entire right, title and interest for the United States and its territorial possessions  in and to said invention and application, including any and all divisions and continuations thereof, and in and to any and all  Letters Patent which may be granted therefor, including any and all renewals, reissues, and prolongations thereof.</p> <p>NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration,  the receipt whereof is hereby acknowledged, I hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal  representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States and  its territorial possessions including any and all divisions and continuations thereof, and any and all Letters Patent which may be  granted therefor, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention  and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted  thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and  advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent  when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE  and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as I might or could have  held and enjoyed the same, if this assignment had not been made.</p> <p>I hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the  same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed  in connection with filing said application and securing Letters Patent thereon.</p> <p>I hereby authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all  divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.</p> <p>I hereby grant LRK Patent Law Firm the power to insert any further identification which may be necessary or desirable in  order to comply with the rules of the U.S. Patent and Trademark Office.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or  imprisonment of not more than five (5) years, or both.</p> <p>IN TESTIMONY WHEREOF, this assignment is executed by me, on the respective date(s) indicated below.</p>	
<b>LEGAL NAME OF INVENTOR</b>	
Inventor: <u>Jae-Hyun KIM</u>	Date: <u>July 23, 2014</u>
Signature: 	

Check the box below and complete the attached page(s) to list additional inventors.  
 Additional inventors are being named on the \_\_\_ supplemental sheet(s) attached hereto.

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Signature

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July 23, 2014  
Date (Optional)

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